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10V Drive Nch MOSFET

RDD050N20

●Structure

Silicon N-channel
MOSFET

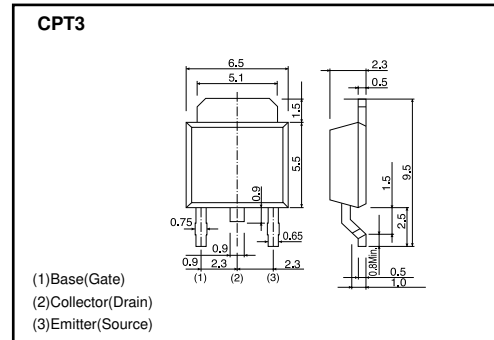
●Features

- 1) Low on-resistance.
- 2) Low input capacitance.
- 3) Excellent resistance to damage from static electricity.

●Application

Switching

●Dimensions (Unit : mm)



●Packaging specifications

| Type | Package | Taping |
|-----------|------------------------------|--------|
| | Code | TL |
| | Basic ordering unit (pieces) | 2500 |
| RDD050N20 | | ○ |

●Absolute maximum ratings (Ta=25°C)

| Parameter | Symbol | Limits | Unit | |
|-----------------------------------|-------------|-------------|----------|---|
| Drain-Source Voltage | V_{DS} | 200 | V | |
| Gate-Source Voltage | V_{GS} | ± 30 | V | |
| Drain Current | Continuous | I_D | ± 5 | A |
| | Pulsed | I_{DP} *1 | ± 20 | A |
| Source Current (Body Diode) | Continuous | I_S | 5 | A |
| | Pulsed | I_{SP} *1 | 20 | A |
| Avalanche Current | I_{AS} *2 | 5 | A | |
| Avalanche Energy | E_{AS} *2 | 75 | mJ | |
| Total Power Dissipation (Tc=25°C) | P_D | 20 | W | |
| Channel Temperature | T_{ch} | 150 | °C | |
| Storage Temperature | T_{stg} | -55 to +150 | °C | |

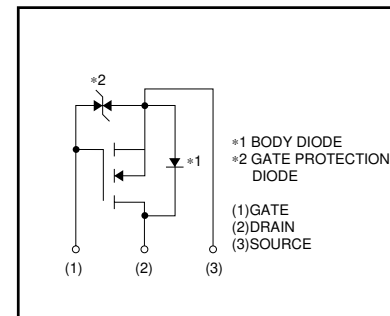
*1 $P_w \leq 10\mu s$, Duty cycle $\leq 1\%$

*2 $L = 4.5mH$, $V_{DD} = 50V$, $R_G = 25\Omega$, 1Pulse, $T_{ch} = 25^\circ C$

●Thermal resistance

| Parameter | Symbol | Limits | Unit |
|-----------------|----------------|--------|------|
| Channel to case | $R_{th(ch-c)}$ | 6.25 | °C/W |

●Equivalent Circuit



*A protection diode is included between the gate and the source terminals to protect the diode against static electricity when the product is in use. Use the protection circuit when the fixed voltages are exceeded.

Transistors

●Electrical characteristics (Ta=25°C)

| Parameter | Symbol | Min. | Typ. | Max. | Unit | Conditions |
|---|-----------------------|------|------|------|------|--|
| Gate-Source Leakage | I _{GSS} | — | — | ±10 | μA | V _{GS} =±30V, V _{DS} =0V |
| Drain-Source Breakdown Voltage | V _{(BR) DSS} | 200 | — | — | V | I _D =1mA, V _{GS} =0V |
| Zero Gate Voltage Drain Current | I _{DSS} | — | — | 25 | μA | V _{DS} =200V, V _{GS} =0V |
| Gate Threshold Voltage | V _{GS(th)} | 2.0 | — | 4.0 | V | V _{DS} =10V, I _D =1mA |
| Static Drain-Source On-State Resistance | R _{DS(on)} * | — | 0.55 | 0.72 | Ω | I _D =2.5A, V _{GS} =10V |
| Forward Transfer Admittance | Y _{fs} * | 1.1 | 1.8 | — | S | V _{DS} =10V, I _D =2.5A |
| Input Capacitance | C _{iss} | — | 292 | — | pF | V _{DS} =10V |
| Output Capacitance | C _{oss} | — | 92 | — | pF | V _{GS} =0V |
| Reverse Transfer Capacitance | C _{rss} | — | 28 | — | pF | f=1MHz |
| Turn-On Delay Time | t _{d(on)} * | — | 10 | — | ns | I _D =2.5A, V _{DD} ÷ 100V |
| Rise Time | t _r * | — | 22 | — | ns | V _{GS} =10V |
| Turn-Off Delay Time | t _{d(off)} * | — | 23 | — | ns | R _L =40Ω |
| Fall Time | t _f * | — | 28 | — | ns | R _G =10Ω |
| Total Gate Charge | Q _g * | — | 9.3 | — | nC | V _{DD} =100V |
| Gate-Source Charge | Q _{gs} * | — | 2.8 | — | nC | V _{GS} =10V |
| Gate-Drain Charge | Q _{gd} * | — | 3.7 | — | nC | I _D =5A |

* Pulsed

●Body diode characteristics (Source-drain) (Ta=25°C)

| Parameter | Symbol | Min. | Typ. | Max. | Unit | Conditions |
|-------------------------|-------------------|------|------|------|------|---|
| Forward voltage | V _{SD} * | — | — | 1.5 | V | I _S = 5.0A, V _{GS} =0V |
| Reverse recovery time | t _{rr} | — | 117 | — | ns | I _{DR} = 5.0A, V _{GS} =0V |
| Reverse recovery charge | Q _{rr} | — | 0.37 | — | μC | di/dt= 100A / μs |

* Pulsed

Transistors

●Electrical characteristic curves

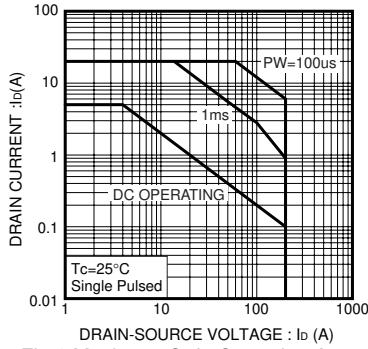


Fig.1 Maximum Safe Operating Area

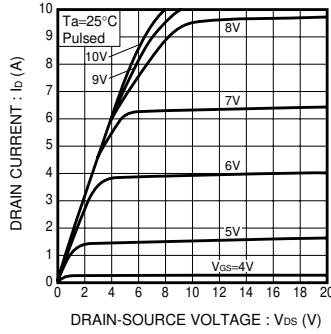


Fig.2 Typical Output Characteristics

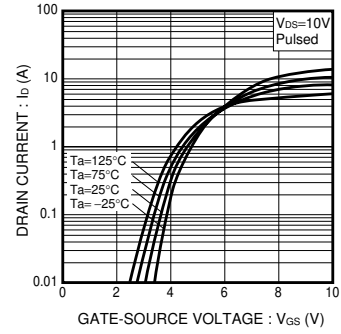


Fig.3 Typical Transfer Characteristics

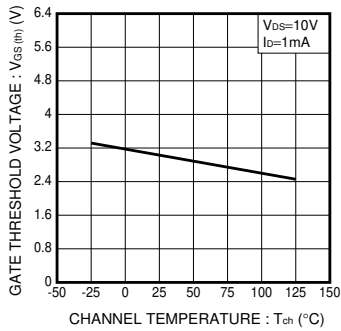


Fig.4 Gate Threshold Voltage vs. Channel Temperature

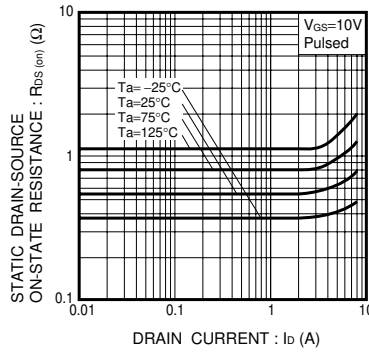


Fig.5 Static Drain-Source On-State Resistance vs. Drain Current

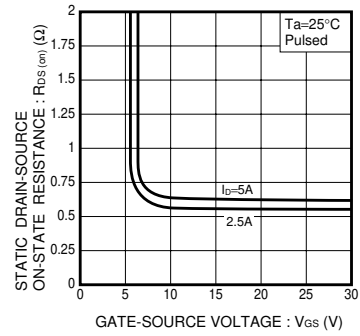


Fig.6 Static Drain-Source On-State Resistance vs. Gate-Source Voltage

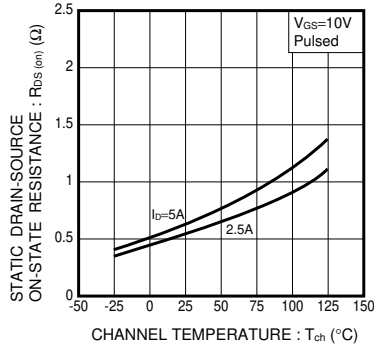


Fig.7 Static Drain-Source On-State Resistance vs. Channel Temperature

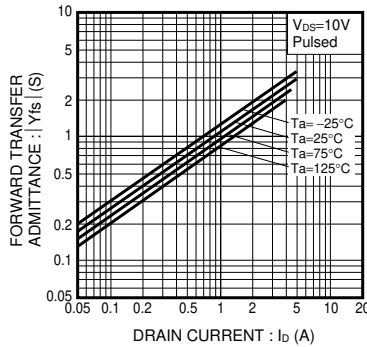


Fig.8 Forward Transfer Admittance vs. Drain Current

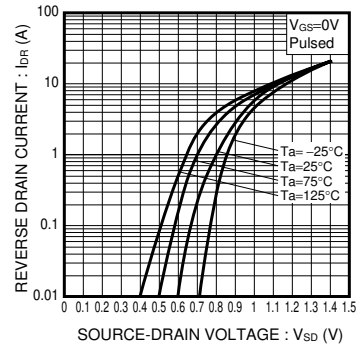


Fig.9 Reverse Drain Current vs. Source-Drain Voltage

Transistors

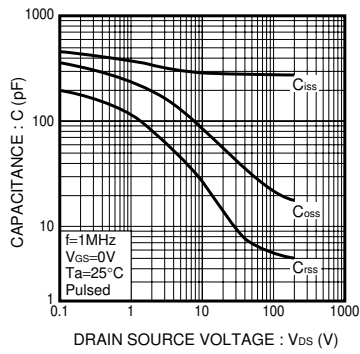


Fig.10 Typical Capacitance vs. Drain-Source Voltage

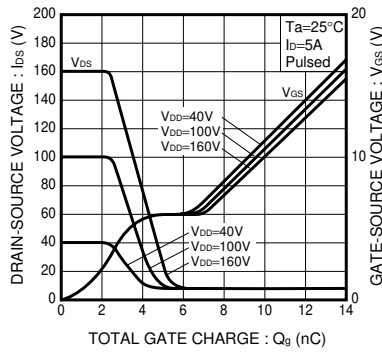


Fig.11 Dynamic Input Characteristics

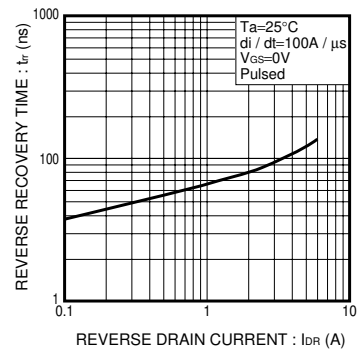


Fig.12 Reverse Recovery Time vs. Reverse Drain Current

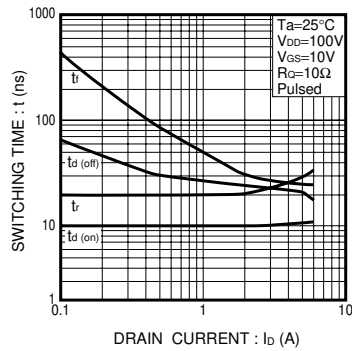


Fig.13 Switching Characteristics

Transistors

●Switching characteristics measurement circuit

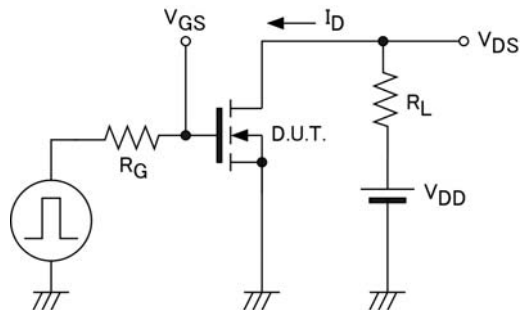


Fig.1-1 Switching time measurement circuit

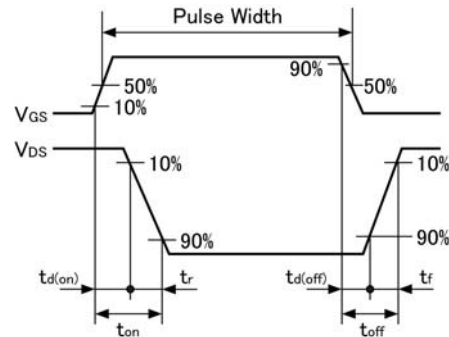


Fig.1-2 Switching waveforms

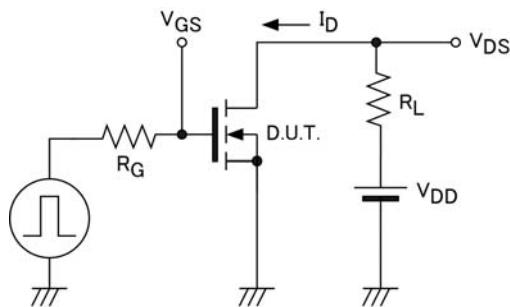


Fig.2-1 Gate charge measurement circuit

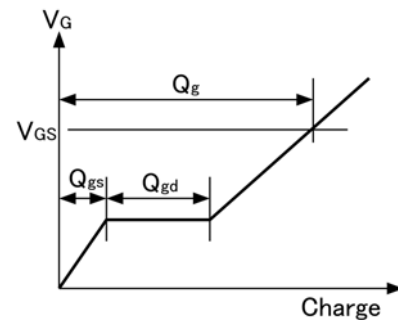


Fig.2-2 Gate charge waveform

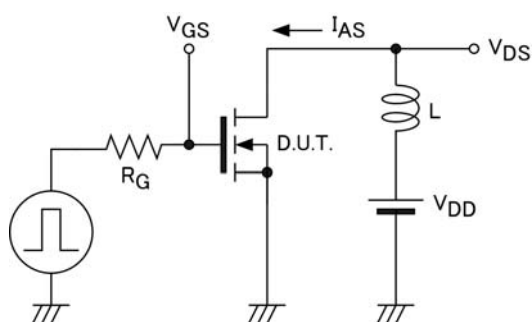


Fig.3-1 Avalanche measurement circuit

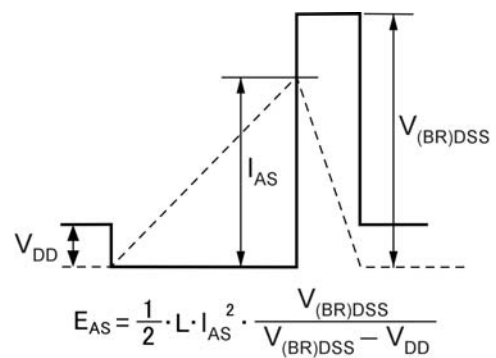


Fig.3-2 Avalanche waveform

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